

P- Channel Enhancement Mode MOSFET
◆ DESCRIPTION

The MT2301 is the P-Channel logic enhancement mode power field effect transistor are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

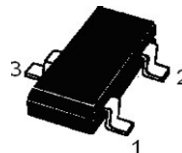
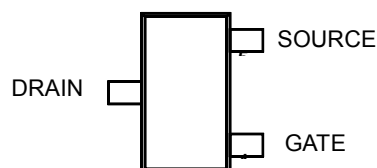
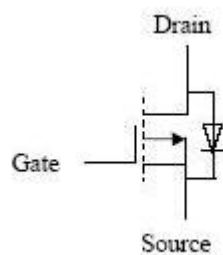
These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other Battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

◆ FEATURES

- -20V/-2.8A, $R_{DS(ON)} = 120m\Omega @ V_{GS} = -4.5V$
- -20V/-2.5A, $R_{DS(ON)} = 170m\Omega @ V_{GS} = -2.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23-3L package design

◆ APPLICATIONS

- POWER Management in Note
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC

◆ PIN CONFIGURATION


P- Channel Enhancement Mode MOSFET
◆ ABSOLUTE MAXIMUM RATINGS

 (T_A=25°C Unless Otherwise Noted)

Parameter		Symbol	Maximum	Unit
Drain-Source Voltage		V _{DS}	-20	V
Gate-Source Voltage		V _{GS}	±12	V
Continuous Drain Current	T _A = 25°C	I _D	-2.8	A
	T _A = 70°C		-1.5	
Pulsed Drain Current		I _{DM}	-10	A
Continuous Source Current (Diode Conduction)		I _S	-1.6	A
Power Dissipation	T _A = 25°C	P _D	1.25	W
	T _A = 70°C		0.8	
Operating junction temperature range		T _J	150	°C
Storage temperature range		T _{STG}	- 55 to 150	°C

◆ THERMAL RESISTANCE RATINGS

Thermal Resistance	Symbol	Maximum	Unit
Junction-to-Ambient	R _{θJA}	100	°C/W

◆ ORDERING INFORMATION

Device	Package	Shipping
MT2301	SOT-23	3000 PCS / Tape & Reel

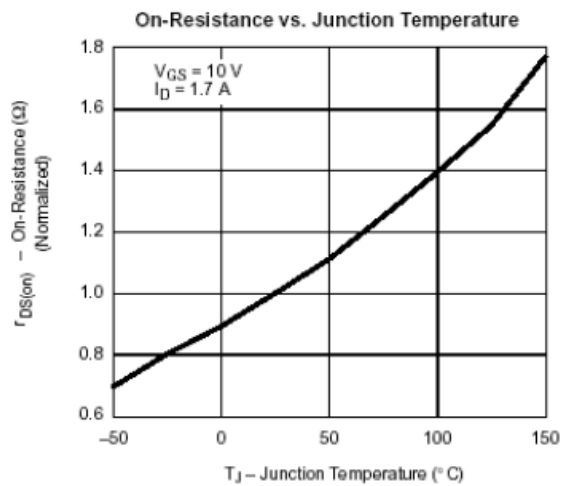
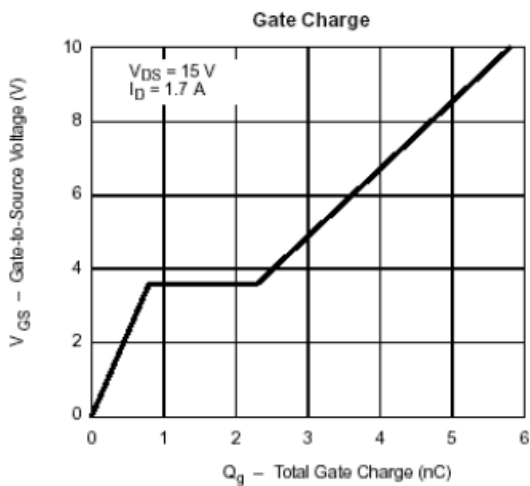
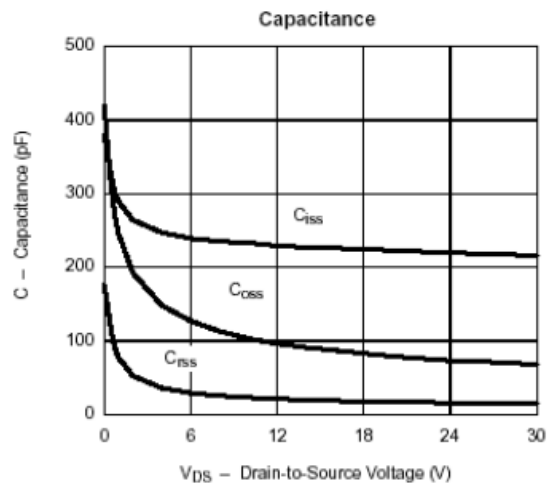
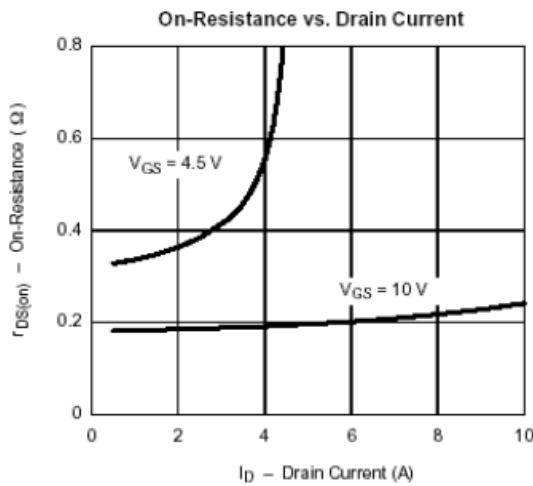
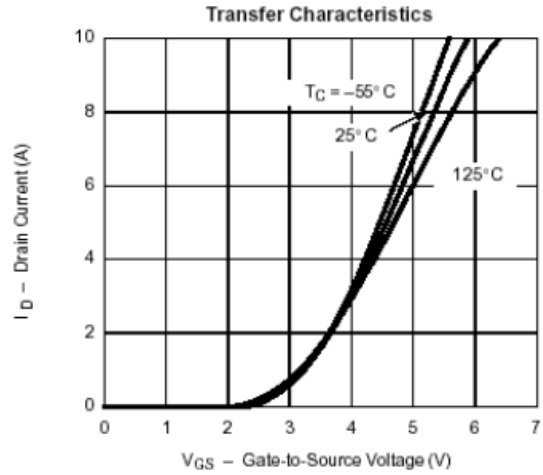
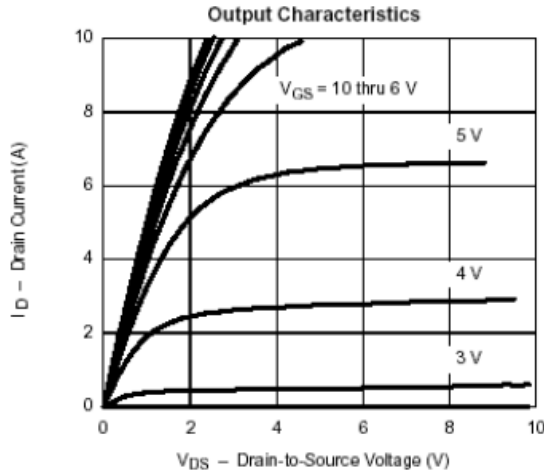
P- Channel Enhancement Mode MOSFET
◆ ELECTRICAL CHARACTERISTICS

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Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Parameters						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-20	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{GS} = V _{DS} , I _D = -250μA	-0.45	-	-1.5	V
Gate Current	I _{GSS}	V _{DS} = 0V, V _{GS} = ± 8 V	-	-	±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -20V, V _{GS} = 0 V	-	-	-1	μA
		V _{DS} = -20V, V _{GS} = 0V, T _J = 55 °C	-	-	-10	
Forward Trans conductance	g _{fs}	V _{DS} = -5V, I _D = -2.8A	-	6.5	-	s
On-State Drain Current	I _{D(ON)}	V _{DS} ≤ -5V, V _{GS} = -4.5V	-6	-	-	A
		V _{DS} ≤ -5V, V _{GS} = -2.5V	-3	-	-	
Drain-Source On Resistance	R _{DS(ON)}	V _{GS} = -4.5V, I _D = -2.8A	-	90	120	mΩ
		V _{GS} = -2.5V, I _D = -2.0A	-	145	170	
Diode Forward Voltage	V _{SD}	I _S = -1.6A, V _{GS} = 0V	-	-0.8	-1.2	V
Dynamic Parameters						
Input Cap.	C _{iss}	V _{DS} = -6V, V _{GS} = 0V, F = 1MHz	-	415	-	pF
Output Cap.	C _{oss}		-	223	-	
Reverse Transfer Cap.	C _{riss}		-	23	-	
Total Gate Charge	Q _g	V _{DS} = -6V, V _{GS} = -4.5V, I _D = -2.8A	-	5.8	10	nC
Gate-Source Charge	Q _{gs}		-	0.85	-	
Gate-Drain Charge	Q _{gd}		-	1.7	-	
Turn-On Time	T _{D(ON)}	V _{DS} = -6V, R _L = 6Ω, I _D = -1A, V _{GEN} = -4.5V, R _G = 6Ω	-	13	25	nS
	t _r		-	36	60	
Turn-Off Time	T _{D(OFF)}		-	42	70	
	t _f		-	34	60	

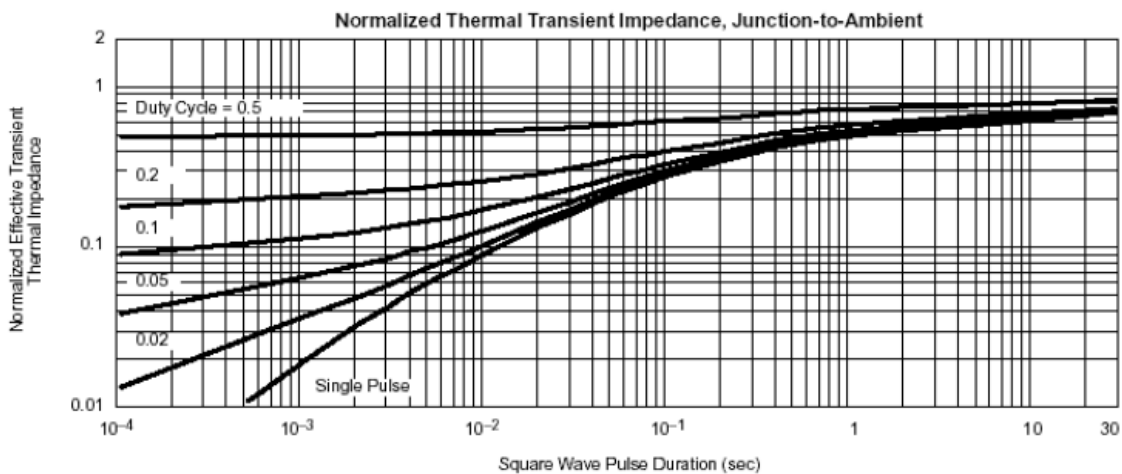
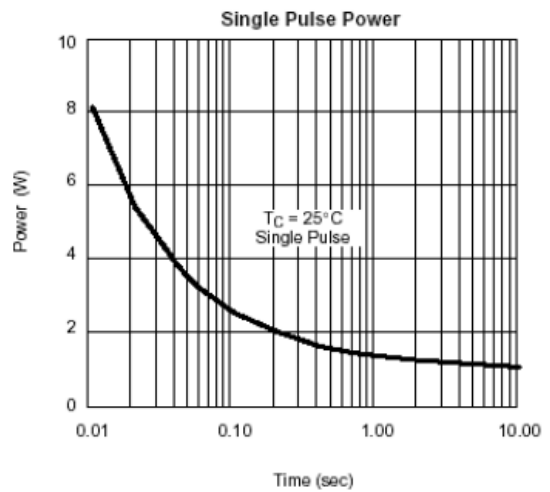
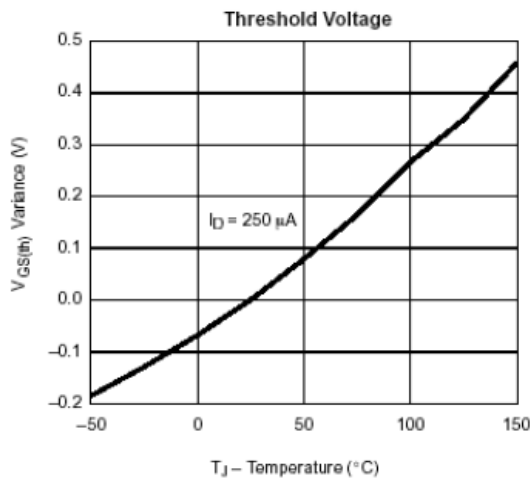
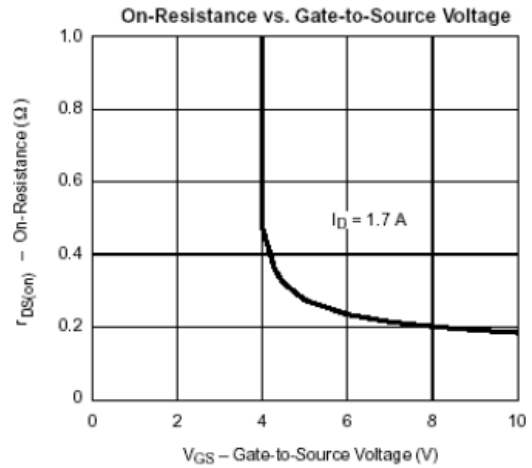
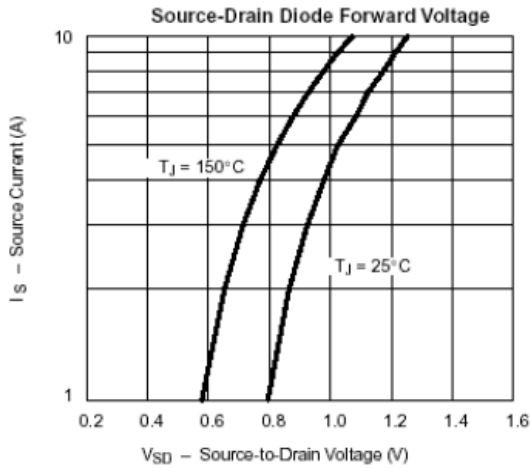
P- Channel Enhancement Mode MOSFET
◆ TYPICAL CHARACTERISTICS

(25°C Unless Noted)



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◆ TYPICAL CHARACTERISTICS

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P- Channel Enhancement Mode MOSFET
◆ PHYSICAL DIMENSIONS
3-Pin surface Mount SOT-23
